



NPN Epitaxial Planar Silicon Transistor **High-Voltage Switching Applications**

Applications

• DC / DC converters, relay drivers, lamp drivers, motor drivers, inverters.

Features

- Adoption of FBET, MBIT processes.
- · Large current capacitance.
- · Low collector-to-emitter saturation voltage.
- · High-speed switching.
- Ultrasmall package permitting applied sets to be small and slim (mounting height: 0.9mm).
- · High allowable power dissipation.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		120	V
Collector-to-Emitter Voltage	VCES		120	V
Collector-to-Emitter Voltage	VCEO		100	V
Emitter-to-Base Voltage	VEBO		6.5	V
Collector Current	IC		2	А
Collector Current (Pulse)	ICP		3	А
Base Current	IB		400	mA
Collector Dissipation	PC	Mounted on a ceramic board (600mm ² X0.8mm)	0.9	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions		Ratings		
	Symbol		min	typ	max	Unit
Collector Cutoff Current	ICBO	VCB=80V, IE=0A			1	μΑ
Emitter Cutoff Current	IEBO	VEB=4V, IC=0A			1	μΑ
DC Current Gain	hFE	V _{CE} =5V, I _C =100mA	300		600	
Gain-Bandwidth Product	fT	VCE=10V, IC=300mA		300		MHz
Output Capacitance	Cob	V _{CB} =10V, f=1MHz		13		pF
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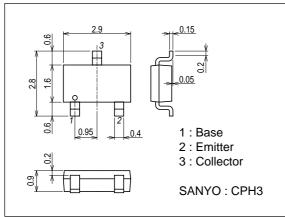
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Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Collector-to-Emitter Saturation Voltage	VCE(sat)	IC=1A, IB=100mA		90	150	mV
Base-to-Emitter Saturation Voltage	V _{BE} (sat)	IC=1A, IB=100mA		0.85	1.2	V
Collector-to-Base Breakdown Voltage	V(BR)CBO	IC=10μA, IE=0A	120			V
Collector-to-Emitter Breakdown Voltage	V(BR)CES	IC=100μA, RBE=0Ω	120			V
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	I _C =1mA, R _{BE} =∞	100			V
Emitter-to-Base Breakdown Voltage	V(BR)EBO	IE=10μA, IC=0A	6.5			V
Turn-ON Time	ton	See specified Test Circuit.		40		ns
Storage Time	tstg	See specified Test Circuit.		1100		ns
Fall Time	tf	See specified Test Circuit.		40		ns

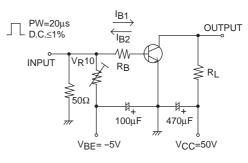
Package Dimensions

unit : mm

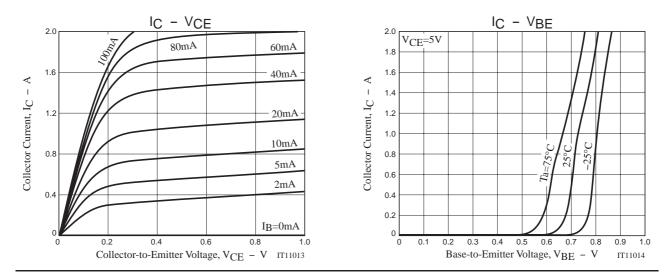


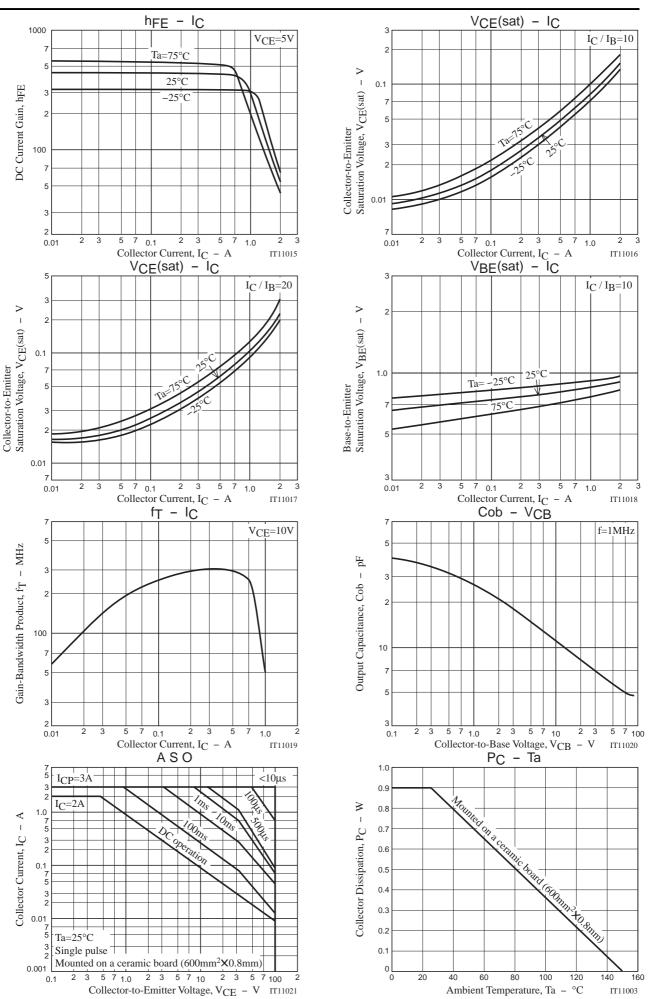


Switching Time Test Circuit



 $10I_{B1} = -10I_{B2} = I_C = 0.5A$





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